HEF4070B Quad 2-input EXCLUSIVE-OR gate Rev. 4 – 27 March 2014

Product data sheet

1. General description

The HEF4070B is a quad 2-input EXCLUSIVE-OR gate. The outputs are fully buffered for the highest noise immunity and pattern insensitivity to output impedance.

It operates over a recommended V_{DD} power supply range of 3 V to 15 V referenced to V_{SS} (usually ground). Unused inputs must be connected to V_{DD} , V_{SS} , or another input.

2. Features and benefits

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from –40 °C to +85 °C
- Complies with JEDEC standard JESD 13-B

3. Applications

- Logical comparators
- Parity checkers and generators

4. Ordering information

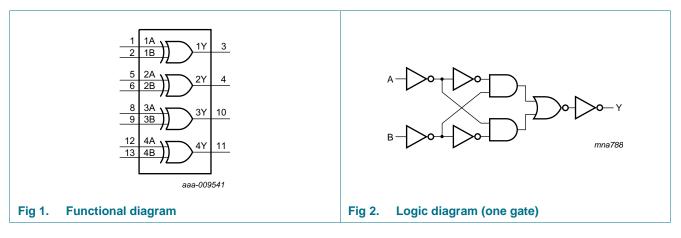
Table 1. Ordering information

Type number	Package							
	Temperature range	Name	Description	Version				
HEF4070BP	–40 °C to +85 °C	DIP14	plastic dual in-line package; 14 leads (300 mil)	SOT27-1				
HEF4070BT	–40 °C to +85 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1				



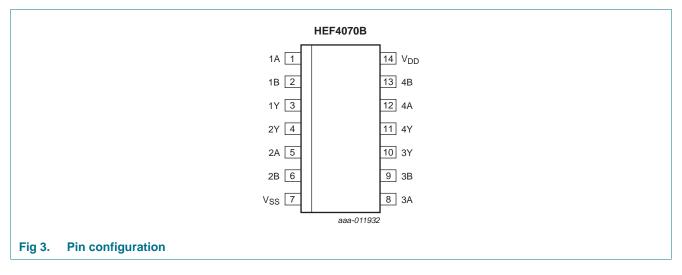
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5. Functional diagram



6. Pinning information

6.1 Pinning



6.2 Pin description

Table 2. Pin description					
Symbol	Pin	Description			
1A, 2A, 3A, 4A	1, 5, 8, 12	data input			
1B, 2B, 3B, 4B	2, 6, 9, 13	data input			
1Y, 2Y, 3Y, 4Y	3, 4, 10, 11	data output			
V _{SS}	7	ground (0 V)			
V _{DD}	14	supply voltage			

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7. Functional description

Input	Output	
nA	nB	nY
L	L	L
L	Н	Н
Н	L	Н
Н	Н	L

[1] H = HIGH voltage level; L = LOW voltage level

8. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to $V_{SS} = 0 V$ (ground).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DD}	supply voltage		-0.5	+18	V
I _{IK}	input clamping current	$V_{I} < -0.5$ V or $V_{I} > V_{DD}$ + 0.5 V	-	±10	mA
VI	input voltage		-0.5	V _{DD} + 0.5	V
Ι _{ΟΚ}	output clamping current	V_{O} < -0.5 V or V_{O} > V_{DD} + 0.5 V	-	±10	mA
I _{I/O}	input/output current		-	±10	mA
I _{DD}	supply current		-	50	mA
T _{stg}	storage temperature		-65	+150	°C
T _{amb}	ambient temperature		-40	+85	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +85 \text{ °C}$			
		DIP14	<u>[1]</u> -	750	mW
		SO14	[2] -	500	mW
Р	power dissipation	per output	-	100	mW

[1] For DIP14 packages: above T_{amb} = 70 °C, P_{tot} derates linearly with 12 mW/K.

[2] For SO14 packages: above T_{amb} = 70 °C, P_{tot} derates linearly with 8 mW/K.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DD}	supply voltage		3	15	V
VI	input voltage		0	V _{DD}	V
T _{amb}	ambient temperature	in free air	-40	+85	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V _{DD} = 5 V	-	3.75	μs/V
		V _{DD} = 10 V	-	0.5	μs/V
		V _{DD} = 15 V	-	0.08	μs/V

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10. Static characteristics

Table 6. Static characteristics

 $V_{SS} = 0$ V; $V_l = V_{SS}$ or V_{DD} ; unless otherwise specified

Symbol	Parameter	Conditions	V _{DD}	T _{amb} =	–40 °C	T _{amb} =	+25 °C	T _{amb} =	_{nb} = +85 °C	
				Min	Max	Min	Max	Min	Max	
VIH	HIGH-level	I _O < 1 μA	5 V	3.5	-	3.5	-	3.5	-	V
	input voltage		10 V	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	V
VIL	LOW-level	I _O < 1 μA	5 V	-	1.5	-	1.5	-	1.5	V
	input voltage		10 V	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	V
V _{OH}	HIGH-level	I _O < 1 μA	5 V	4.95	-	4.95	-	4.95	-	V
011	output voltage		10 V	9.95	-	9.95	-	9.95	-	V
			15 V	14.95	-	14.95	-	14.95	-	V
V _{OL}	LOW-level output voltage	I _O < 1 μA	5 V	-	0.05	-	0.05	-	0.05	V
(10 V	-	0.05	-	0.05	-	0.05	V
			15 V	-	0.05	-	0.05	-	0.05	V
I _{OH}	HIGH-level	V _O = 2.5 V	5 V	-	-1.7	-	-1.4	-	-1.1	mA
	output current	V _O = 4.6 V	5 V	-	-0.52	-	-0.44	-	-0.36	mA
		V _O = 9.5 V	10 V	-	-1.3	-	-1.1	-	-0.9	mA
		V _O = 13.5 V	15 V	-	-3.6	-	-3.0	-	-2.4	mA
I _{OL}	LOW-level	V _O = 0.4 V	5 V	0.52	-	0.44	-	0.36	-	mA
	output current	V _O = 0.5 V	10 V	1.3	-	1.1	-	0.9	-	mA
		V _O = 1.5 V	15 V	3.6	-	3.0	-	2.4	-	mA
l _l	input leakage current		15 V	-	±0.3	-	±0.3	-	±1.0	μA
I _{DD}	supply current	all valid input combinations;	5 V	-	1.0	-	1.0	-	7.5	μA
		$I_{O} = 0 A$	10 V	-	2.0	-	2.0	-	15.0	μA
			15 V	-	4.0	-	4.0	-	30.0	μA
CI	input capacitance			-	-	-	7.5	-	-	pF

11. Dynamic characteristics

Table 7. Dynamic characteristics

 $T_{amb} = 25 \text{ °C}$; waveforms see <u>Figure 4</u>; test circuit see <u>Figure 5</u>; unless otherwise specified.[1]

Symbol	Parameter	Conditions	V _{DD}	Extrapolation formula	Min	Тур	Max	Unit
t _{PHL}		nA or nB to nY	5 V	58 ns + (0.55 ns/pF)C _L	-	85	175	ns
	propagation delay		10 V	24 ns + (0.23 ns/pF)C _L	-	35	75	ns
			15 V	21 ns + (0.16 ns/pF)C _L	-	30	55	ns
t _{PLH}		nA or nB to nY	5 V	43 ns + (0.55 ns/pF)C _L	-	75	150	ns
	propagation delay		10 V	19 ns + (0.23 ns/pF)C _L	-	30	65	ns
			15 V	17 ns + (0.16 ns/pF)C _L	-	25	50	ns
t _t	transition time		5 V [2]	10 ns + (1.00 ns/pF)C _L	-	60	120	ns
			10 V	9 ns + (0.42 ns/pF)C _L	-	30	60	ns
			15 V	6 ns + (0.28 ns/pF)C _L	-	20	40	ns

[1] The typical value of the propagation delay and output transition time can be calculated with the extrapolation formula (C_L in pF).

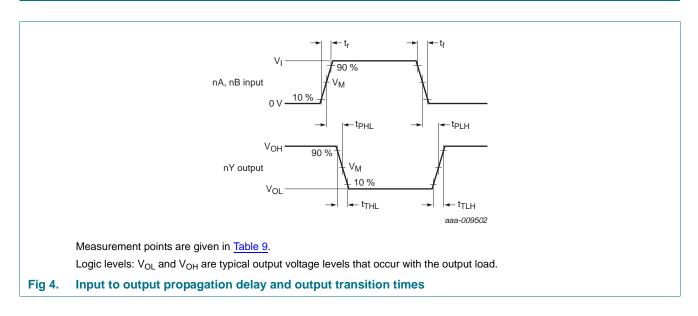
[2] t_t is the same as t_{THL} and t_{TLH} .

Table 8.Dynamic power dissipation

 $V_{SS} = 0 V; t_r = t_f \le 20 ns; T_{amb} = 25 \ ^{\circ}C.$

Symbol	Parameter	V_{DD}	Typical formula	where:
PD	dynamic power dissipation	5 V	$P_D = 1100 \times f_i + \Sigma(f_o \times C_L) \times V_DD^2 \; (\muW)$	$f_i = input frequency in MHz;$
		10 V	$P_D = 4900 \times f_i + \Sigma(f_o \times C_L) \times V_DD^2 \ (\muW)$	$f_o = output frequency in MHz;$
		15 V	$P_{D} = 14400 \times f_{i} + \Sigma(f_{o} \times C_{L}) \times V_{DD}^2 (\muW)$	C_L = output load capacitance in pF;
				$\Sigma(f_o \times C_L)$ = sum of the outputs;
				V_{DD} = supply voltage in V.

12. Waveforms



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Measurement points

Input

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Output

		-					
V _{DD}	V _M	V _M					
5 V to 15 V	0.5V _{DD}	0.5V _{DD}					
Test data is given in <u>Table 10</u> .							
Definitions for test circuit:							
DUT = Device Under Test.							
C _L = load capacitance including j	C_L = load capacitance including jig and probe capacitance.						
R _T = termination resistance shou	R_T = termination resistance should be equal to the output impedance Z_o of the pulse generator.						
Fig 5. Test circuit							

Table 10. Test data

Supply voltage	Input	Load	
V _{DD}	VI	t _r , t _f	CL
5 V to 15 V	V _{SS} or V _{DD}	≤ 20 ns	50 pF

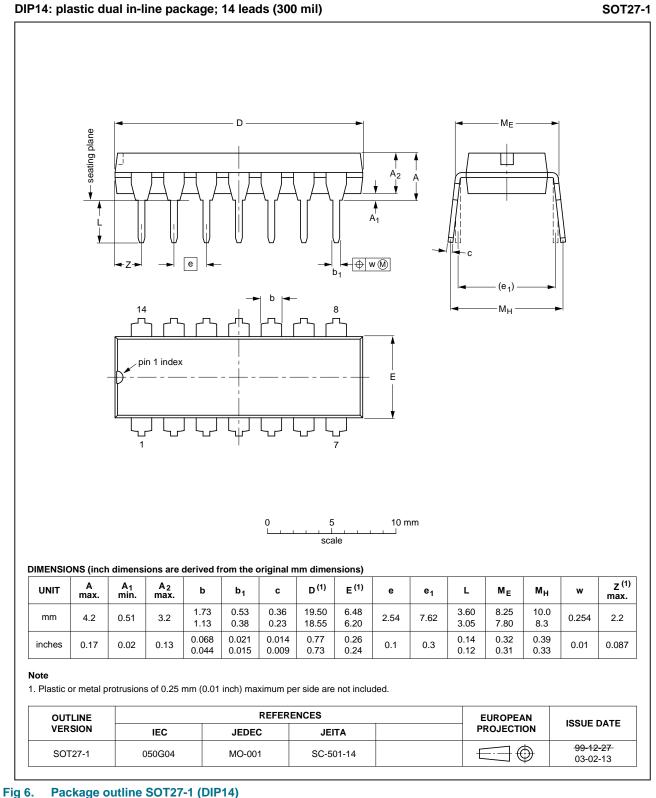
VDD

Table 9.

Supply voltage

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13. Package outline



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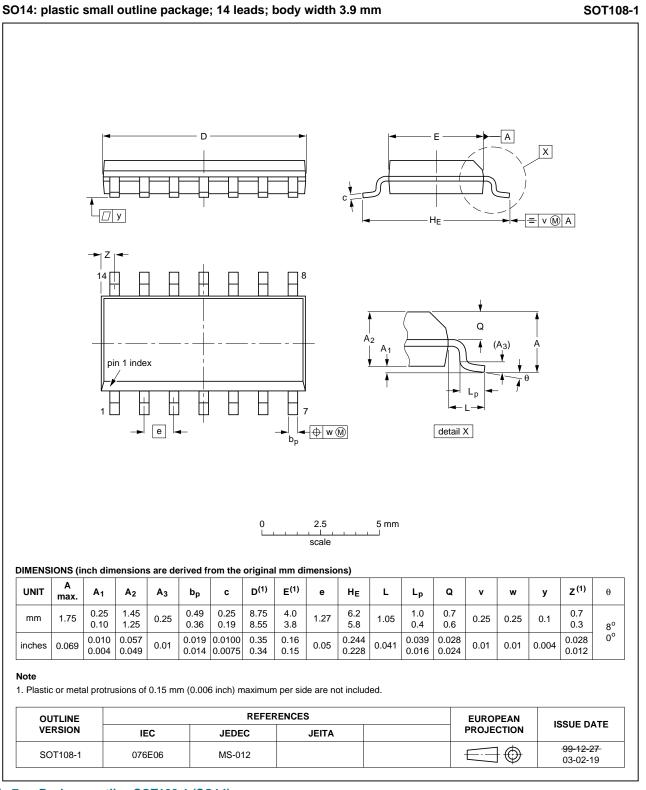


Fig 7. Package outline SOT108-1 (SO14)

14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
HEF4070B v.4	20140327	Product data sheet	-	HEF4070B_CNV v.3			
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 						
	 Legal texts have been adapted to the new company name where appropriate. 						
HEF4070B_CNV v.3	19950101	Product specification	-	-			

Table 11. Revision history

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15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

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